

HSF

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

NOTES:

Current Rating: 3.0AMP
Contact Resistance: 35mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 500MΩ Min
Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
Contact Plating: Au and Sn over Ni
Shell Material: Zinc Alloy
Shell Plating: Ni 100u"
Fixing Material: Phosphor Bronze
Fixing Plating: Sn over Ni
Housing Material: PBT+30%G.F.(UL94V-0)
Cover Material: PBT+30%G.F.(UL94V-0)

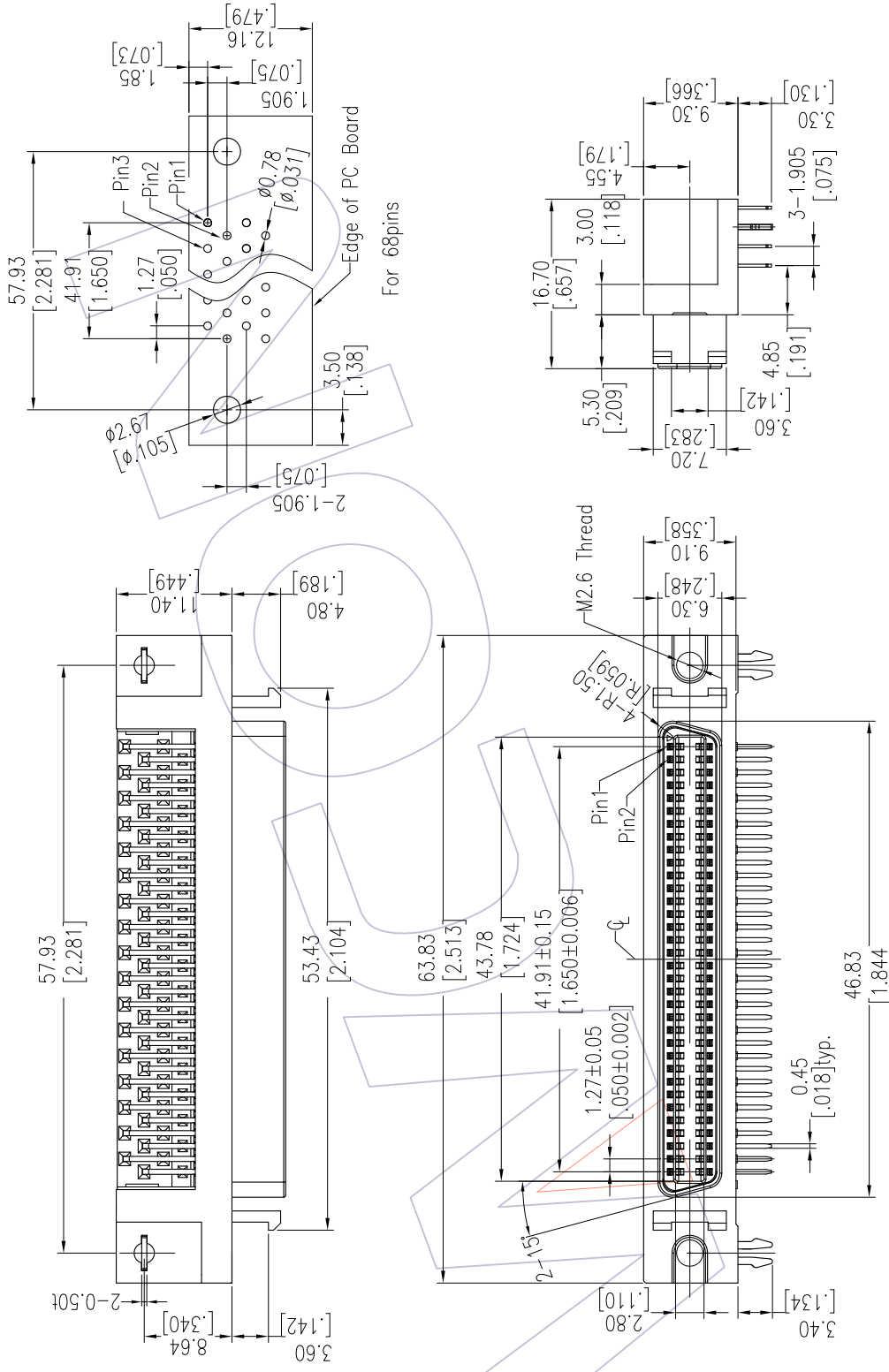
Ordering Information

6321-0 68 R D SX M W A 02

No. of Pins
68P

Contact Plating
S1=3u"Gold/Tin
S3=10u"Gold/Tin
S4=15u"Gold/Tin
S5=30u"Gold/Tin

A=Tray



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PART NO.: 6321-068RDSXMMWA02

TITLE:
1.27PITCH CEN TYPE
SCSI FEMALE DIP (鱼叉横向)

Customer NO.

OPERATION	DRAW	DATE	SCALE	FIT	UNIT	mm
x.x	±0.40	2016/06/28				
x.xx	±0.25	CHECK				
x.xxx	±0.15	DATE				
Angle	± 3'	APPROVE				
DIM	TOL	DATE				
CHANGE						
DESCRIPTION						
NEW						
REV	DATE	MODIFICATION				